

|                                   |  |                         |   |             |
|-----------------------------------|--|-------------------------|---|-------------|
| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination |             |
|                                   |  | 10/774,961              | HOSHINO ET AL.                          |             |
|                                   |  | Examiner                | Art Unit                                | Page 1 of 1 |
|                                   |  | Philip H. Leung         | 3742                                    |             |

**U.S. PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name          | Classification |
|---|---|--|-----------------|---------------|----------------|
| * | A | US-2005/0011884                                  | 01-2005         | Wu, Ronghua   | 219/630        |
| * | B | US-6,681,998                                     | 01-2004         | Sharpe et al. | 239/13         |
|   | C | US-  |                 |               |                |
|   | D | US-  |                 |               |                |
|   | E | US-  |                 |               |                |
|   | F | US-  |                 |               |                |
|   | G | US-  |                 |               |                |
|   | H | US-  |                 |               |                |
|   | I | US-  |                 |               |                |
|   | J | US-  |                 |               |                |
|   | K | US-  |                 |               |                |
|   | L | US-  |                 |               |                |
|   | M | US-  |                 |               |                |

**FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name | Classification |
|---|---|--|-----------------|---------|------|----------------|
|   | N |  |                 |         |      |                |
|   | O |  |                 |         |      |                |
|   | P |  |                 |         |      |                |
|   | Q |  |                 |         |      |                |
|   | R |  |                 |         |      |                |
|   | S |  |                 |         |      |                |
|   | T |  |                 |         |      |                |

**NON-PATENT DOCUMENTS**

|   |   |   |
|---|---|---|
| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|   | U |   |
|   | V |   |
|   | W |   |
|   | X |   |

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.